

Vishay

COMPLIANT

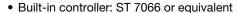
## 16 x 1 Character LCD



#### **FEATURES**

· Type: Character





• Duty cycle: 1/16

• 5 x 8 dots includes cursor

• + 5 V power supply

• LED can be driven by pin 1, pin 2, pin 15, pin 16, or A and K

 Material categorization: For definitions of compliance please see <a href="https://www.vishav.com/doc?99912"><u>www.vishav.com/doc?99912</u></a>

MECHANICAL DATA								
ITEM	STANDARD VALUE	UNIT						
Module Dimension	85.0 x 28.0 x 13.5							
Viewing Area	66.0 x 16.0							
Dot Size	0.55 x 0.75	mm						
Dot Pitch	0.63 x 0.83	] '''''						
Mounting Hole	80.0 x 23.0							
Character Size	3.07 x 6.56							

ABSOLUTE MAXIMUM RATINGS										
ITEM	SYMBOL	STAN	IDARD V	ALUE	UNIT					
I I EIVI	STWIDOL	MIN.	TYP.	MAX.	UNII					
Power Supply	$V_{DD}$ to $V_{SS}$	- 0.3	-	7.0	V					
Input Voltage	VI	V <sub>SS</sub>	-	$V_{DD}$	[					

#### Note

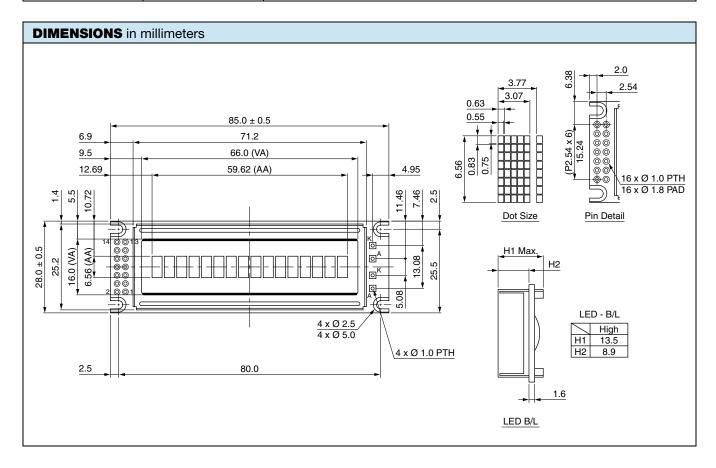
• V<sub>SS</sub> = 0 V, V<sub>DD</sub> = 5.0 V

ELECTRICAL CHARACTERSITICS										
ITEM	SYMBOL	CONDITION	ST	ANDARD VAL	.UE	UNIT				
IIEM	STIVIBOL	CONDITION	MIN.	TYP.	MAX.	UNIT				
Input Voltage	$V_{DD}$	$V_{DD} = + 5 V$	4.5	5.0	5.5	V				
Supply Current	I <sub>DD</sub>	$V_{DD} = + 5 V$	-	1.2	-	mA				
		- 20 °C	-	-	5.5					
Recommended LC Driving	V <sub>DD</sub> to V <sub>0</sub>	0 °C	-	-	-					
Voltage for Normal Temperature		25 °C	-	4.5	-	V				
Version Module		50 °C	-	-	-					
		70 °C	3.5	-	-					
LED Forward Voltage	$V_{F}$	25 °C	-	-	-	V				
LED Forward Current	I <sub>F</sub>	25 °C	-	-	-	mA				
EL Power Supply Current	I <sub>EL</sub>	V <sub>EL</sub> = 110 V <sub>AC</sub> , 400 Hz	-	-	-	mA				

DISPLAY CHAR	ACTE	R AD	DRE	SS C	ODE											
Display Position																
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16
DD RAM Address	00	01	02	03	04	05	06	07	40	41	42	43	44	45	46	47

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INTERFACE PI	TERFACE PIN FUNCTION							
PIN NO.	SYMBOL	FUNCTION						
1	V <sub>SS</sub>	Ground						
2	V <sub>DD</sub>	Supply voltage for logic (+ 5 V)						
3	V <sub>0</sub>	Operating voltage for LCD (variable)						
4	RS	H/L; H: data/L: instruction code						
5	R/W	H/L; H: read (MPU $\rightarrow$ module)/L: write (MPU $\rightarrow$ module)						
6	E	$H, H \rightarrow L$ chip enable signal						
7	DB0	H/L data bus line						
8	DB1	H/L data bus line						
9	DB2	H/L data bus line						
10	DB3	H/L data bus line						
11	DB4	H/L data bus line						
12	DB5	H/L data bus line						
13	DB6	H/L data bus line						
14	DB7	H/L data bus line						





## 1. Module Classification Information

<b>LCD</b>	-016	N	<i>001</i>	$\boldsymbol{B}$	<b>-</b> T	$\boldsymbol{F}$	H	<i>-ET</i>
$\bigcirc$	2)	(3)	<b>4</b> )	(5)	6	(7)	(8)	9

1. Brand: Vishay Intertechnology, Inc.

Horizontal Format: 16 characters

3. Display Type : N→Character Type, H→Graphic Type

4. Vertical Format: 1 Line

5. Model serials no.: B

6. Backlight Type :  $N\rightarrow$ Without backlight  $T\rightarrow$ LED, White

 $B\rightarrow EL$ , Blue green  $A\rightarrow LED$ , Amber

 $D\rightarrow EL$ , Green  $R\rightarrow LED$ , Red

 $W\rightarrow EL$ , White  $O\rightarrow LED$ , Orange

 $F \rightarrow CCFL$ , White  $G \rightarrow LED$ , Green

Y→LED, Yellow Green

7. LCD Mode : B→TN Positive, Gray T→FSTN Negative

N→TN Negative,

G→STN Positive, Gray

Y→STN Positive, Yellow Green

M→STN Negative, Blue

F→FSTN Positive

8. LCD Polarizer A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View direction

G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00

J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

9. Special Code ET: English and European standard font

Compliant with the ROHS Directions and regulations



## 2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2) Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3) Don't disassemble the LCM.
- (4) Don't operate it above the absolute maximum rating.
- (5) Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Supplier has the right to change the passive components
- (9) Supplier has the right to change the PCB Rev.

# 3. General Specification

STANDARD VALUE	UNIT
16 characters×1 Lines	
85.0×28.0×13.5(MAX)mm	mm
66.0×16.0mm	mm
59.62×6.56mm	mm
(L)0.55×(W)0.75mm	
(L)0.63×(W)0.83mm	
(L)3.07×(W)6.56mm	mm
(L)3.77×(W)6.56mm	mm
FSTN Positive Transflection (In LCD production, It will occur slightly We can only guarantee the same color in the same	color difference.
1/16	
6 o'clock	
LED White	
	16 characters×1 Lines  85.0×28.0×13.5(MAX)mm  66.0×16.0mm  59.62×6.56mm  (L)0.55×(W)0.75mm  (L)0.63×(W)0.83mm  (L)3.07×(W)6.56mm  (L)3.77×(W)6.56mm  FSTN Positive Transflection of the same color in the same col



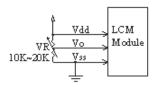
# 4. Absolute Maximum Ratings

ITEM	SYMBOL	MIN.	TYP.	MAX.	UNIT
Operating Temperature	$T_{OP}$	-20		+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	$T_{ST}$	-30		+80	$^{\circ}\!\mathbb{C}$
Input Voltage	$V_{I}$	$ m V_{SS}$		$V_{DD}$	V
Supply Voltage For Logic	$ m V_{DD} ext{-}V_{SS}$	-0.3	_	7	V
Supply Voltage For LCD	$V_{DD}$ - $V_0$	-0.3	_	13	V

# **5. Electrical Characteristics**

ITEM	SYMBO L	CONDITIO N	MIN.	TYP.	MAX.	UNIT
Supply Voltage For Logic	$V_{DD}$ - $V_{SS}$	_	4.5	5.0	5.5	V
Supply Voltage For LCD		Ta=-20°C			5.5	V
*Note	$V_{DD}$ - $V_0$	Ta=25°C	_	4.5	_	V
		Ta=70°C	3.5			V
Input High Vol	$V_{\mathrm{IH}}$	_	$0.7~\mathrm{V_{DD}}$	_	$V_{DD}$	V
Input Low Vol	$V_{IL}$	_	$V_{SS}$	_	0.6	V
Output High Vol	$V_{OH}$	_	3.9	_	_	V
Output Low Vol.	$V_{OL}$	_	_	_	0.4	V
Supply Current	$I_{DD}$	V <sub>DD</sub> =5V	_	1.2	_	mA

<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board





# 6. Optical Characteristics

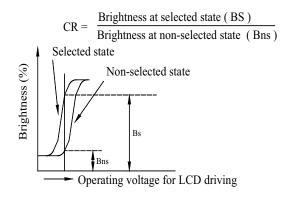
ITEM	SYMBAL	CONDITION	MIN.	TYP.	MAX.	UNIT
	(V) θ	CR≧2	30		60	deg
View Angle	(H) φ	CR≧2	-45		45	deg
Contrast Ratio	CR	_		5		_
	T rise	_		100	150	ms
Response Time	T fall	_		100	150	ms

#### 6.1 Definitions

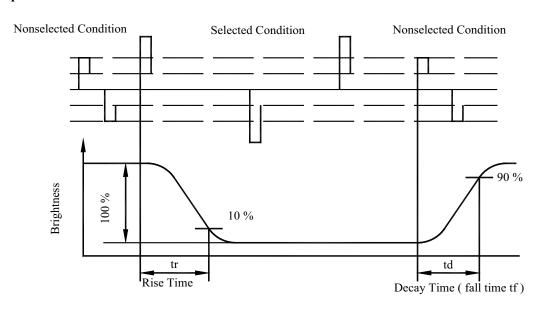
#### View Angles

# LCD X (Visual angle direction)

#### Contrast Ratio



#### **Response Time**



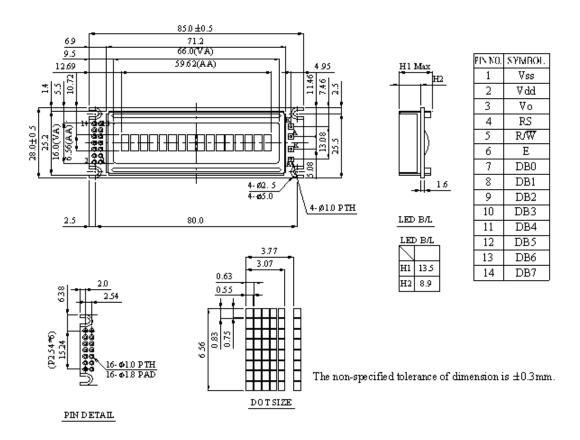


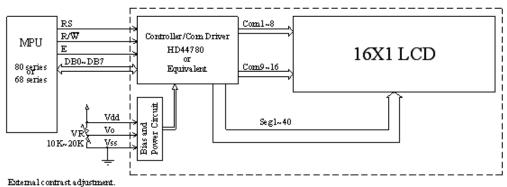
# 7. Interface Pin Function

Pin No.	Symbol	Level	Description
1	$V_{SS}$	0V	Ground
2	$ m V_{DD}$	5.0V	Supply Voltage for logic
3	VO	(Variable)	Operating voltage for LCD
4	RS	H/L	H:DATA, L:Instruction code
5	R/W	H/L	H:Read(MPU→Module)L:Write(MPU→Module)
6	Е	H,H→L	Chip enable signal
7	DB0	H/L	Data bus line
8	DB1	H/L	Data bus line
9	DB2	H/L	Data bus line
10	DB3	H/L	Data bus line
11	DB4	H/L	Data bus line
12	DB5	H/L	Data bus line
13	DB6	H/L	Data bus line
14	DB7	H/L	Data bus line



# 8. Contour Drawing & Block Diagram





Character located 1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 DDRAM address 00 01 02 03 04 05 06 07 40 41 42 43 44 45 46 47

2-line display mode.



# **9. Function Description**

The LCD display Module is built in a LSI controller, the controller has two 8-bit registers, an instruction register (IR) and a data register (DR).

The IR stores instruction codes, such as display clear and cursor shift, and address information for display data RAM (DDRAM) and character generator (CGRAM). The IR can only be written from the MPU. The DR temporarily stores data to be written or read from DDRAM or CGRAM. When address information is written into the IR, then data is stored into the DR from DDRAM or CGRAM. By the register selector (RS) signal, these two registers can be selected.

RS	R/W	Operation
0	0	IR write as an internal operation (display clear, etc.)
0	1	Read busy flag (DB7) and address counter (DB0 to DB7)
1	0	Write data to DDRAM or CGRAM (DR to DDRAM or CGRAM)
1	1	Read data from DDRAM or CGRAM (DDRAM or CGRAM to DR)

#### **Busy Flag (BF)**

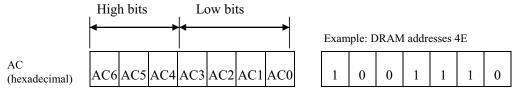
When the busy flag is 1, the controller LSI is in the internal operation mode, and the next instruction will not be accepted. When RS=0 and R/W=1, the busy flag is output to DB7. The next instruction must be written after ensuring that the busy flag is 0.

Address Counter (AC)

The address counter (AC) assigns addresses to both DDRAM and CGRAM

#### **Display Data RAM (DDRAM)**

This DDRAM is used to store the display data represented in 8-bit character codes. Its extended capacity is 80x8 bits or 80 characters. Below figure is the relationship between DDRAM addresses and positions on the liquid crystal display.



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#### DDRAM Address

#### Display position DDRAM address

1								9							
00	01	02	03	04	05	06	07	40	41	42	43	44	45	46	47

1-Line by 16-Character Display

#### **Character Generator ROM (CGROM)**

The CGROM generate  $5\times8$  dot or  $5\times10$  dot character patterns from 8-bit character codes. See Table 2.

#### **Character Generator RAM (CGRAM)**

In CGRAM, the user can rewrite character by program. For 5x8 dots, eight character patterns can be written, and for 5x10 dots, four character patterns can be written.

Write into DDRAM the character code at the addresses shown as the left column of table 1. To show the character patterns stored in CGRAM.

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#### Relationship between CGRAM Addresses, Character Codes (DDRAM) and Character patterns

#### Table 1.

For 5 \* 8 dot character patterns

Character Codes ( DDRAM data )	CGRAM Address	Character Patterns ( CGRAM data )	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 1 0 1 0 0 1 1 1 0 0 1 1 1 1 1 0 1 1 1 1 0 0 0 0 0 0 0 0 0 1	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern(1)  Cursor pattern
0 0 0 0 * 0 0 1	0 1 0 0 1 1 0 0 1 1 0 0 1 1 1 0 0 1 1 1 0 0 0	* * * * * * * * * * * * * * * * * * *	Character pattern(2)  Cursor pattern
	0 0 0		
0 0 0 0 * 1 1 1	$ \begin{array}{c ccccccccccccccccccccccccccccccccccc$	* * *	

For 5 \* 10 dot character patterns

Character Codes ( DDRAM data )	CGRAM Address	Character Patterns ( CGRAM data )	
7 6 5 4 3 2 1 0	5 4 3 2 1 0	7 6 5 4 3 2 1 0	
High Low	High Low	High Low	
0 0 0 0 * 0 0 0	0 0 0 0 0 0 0 0 0 0 0 1 0 0 0 1 1 0 0 0 1 0 0 0 1 0 0 0 1 0 1 0 1 0 0 0 1 1 1 1 1 1 1 1 0 0 0 0 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 0 1 1 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 1 0 0 0 1 1 0 0 1 0 1 0 0 1 0 1 0 0 1 0 1 0 0 1 0 1 0 0 1 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 1 0 0 0 1 0 0 0 1 0	* * * * 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	Character pattern  Cursor pattern
	1 1 1 1	* * * * * * * *	

■ : " High "



# 10.Character Generator ROM Pattern

#### Table.2

Upper																
4 bit Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)	**!**					**	<u> </u>			***	Ħ	# # #		**************************************	****
LLLH	CG RAM (2)	*****					-:::1	-:::[	· · · ![	-::::		* *	.,!	**!**	****	i.,;:
LLHL	CG RAM (3)		11	****			ļi	1-"			 ::	###	:[:[:		,"". ",","	
LLHH	CG RAM (4)					****			-:::	,". ::	,, !!	*,	!:			
LHLL	CG RAM (5)							****	-:::	:::::		••	-4:-1		*****	
LHLH	CG RAM (6)		****					<b> </b>	-:::	==			.*!*.			
LHHL	CG RAM (7)							1	-331	, ![			••[-•			
LHHH	CG RAM (8)			=======================================			-::::		====	 !!		"	:	, <sup>1</sup> .	1,,	!!
HLLL	CG RAM (1)	" " " " " " " " " " " " " " " " " " "	<b>!</b>	}			!-"!	[:-:]				*	•••••	11	<b>]</b> -:	
HLLH	CG RAM (2)	***		====		1,,1		-:::								-1;-[
HLHL	CG RAM (3)	."."	-4-	==			-,:			ii		", ""	****			
НЦНН	CG RAM (4)		}	17			<b>!</b> ::	-="-	***	!***;	- " " " " " " " " " " " " " " " " " " "	·:::		1111	i,,::	* # # # # # # # # # # # # # # # # # # #
HHLL	CG RAM (5)		<b>;</b>	***		****	1									
HHLH	CG RAM (6)	1"1,1	****	****		***		=======================================	**	****	.""." !"!	****	11			
HHHL	CG RAM (7)		==			***,	i-"i	***,*								
нннн	CG RAM (8)			****		****	I)	::::		:·		****			!!*	



## **11.Instruction Table**

Y				Ins	structi	ion Co	de				Day 1 (fa	Execution time
Instruction	RS	R/W	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	Description	(fosc=270Khz)
Clear Display	0	0	0	0	0	0	0	0	0	1	Write "00H" to DDRAM and set DDRAM address to "00H" from AC	1.53ms
Return Home	0	0	0	0	0	0	0	0	1	_	Set DDRAM address to "00H" from AC and return cursor to its original position if shifted. The contents of DDRAM are not changed.	1.53ms
Entry Mode Set	0	0	0	0	0	0	0	1	I/D	SH	Assign cursor moving direction and enable the shift of entire display.	39 μ s
Display ON/OFF Control	0	0	0	0	0	0	1	D	С	В	Set display (D), cursor (C), and blinking of cursor (B) on/off control bit.	39 μ s
Cursor or Display Shift	0	0	0	0	0	1	S/C	R/L	_	_	Set cursor moving and display shift control bit, and the direction, without changing of DDRAM data.	39 μ s
Function Set	0	0	0	0	1	DL	N	F	_	_	Set interface data length (DL:8-bit/4-bit), numbers of display line (N:2-line/1-line)and, display font type (F:5×11 dots/5×8 dots)	39 μ s
Set CGRAM Address	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address in address counter.	39 μ s
Set DDRAM Address	0	0	1	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address in address counter.	39 μ s
Read Busy Flag and Address	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Whether during internal operation or not can be known by reading BF. The contents of address counter can also be read.	0 μ s
Write Data to RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data into internal RAM (DDRAM/CGRAM).	43 μ s
Read Data from RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM).	43 μ s

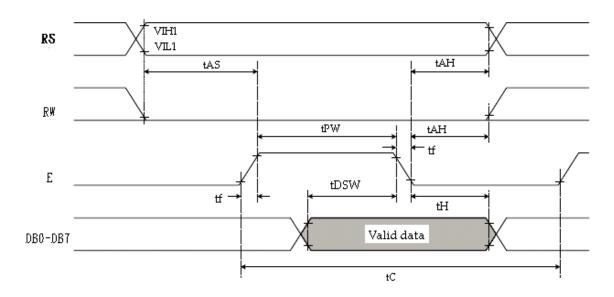
\* "-": don't care



# 12. Timing Characteristics

## 12.1 Write Operation

Writing data from MPU



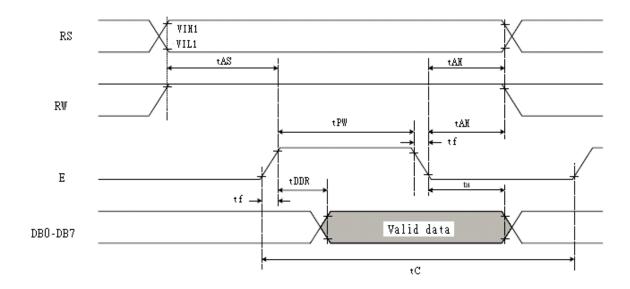
 $Ta=25^{\circ}C$ , VDD=5.0V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	$T_{\rm C}$	1200	_	_	ns
Enable pulse width	$T_{PW}$	140	_	_	ns
Enable rise/fall time	$T_R, T_F$	_	_	25	ns
Address set-up time (RS, R/W to E)	$t_{AS}$	0	_	_	ns
Address hold time	$t_{AH}$	10	_	_	ns
Data set-up time	t <sub>DSW</sub>	40	_	_	ns
Data hold time	t <sub>H</sub>	10	_	_	ns



## 12.2 Read Operation

#### Reading data from \$T7066U

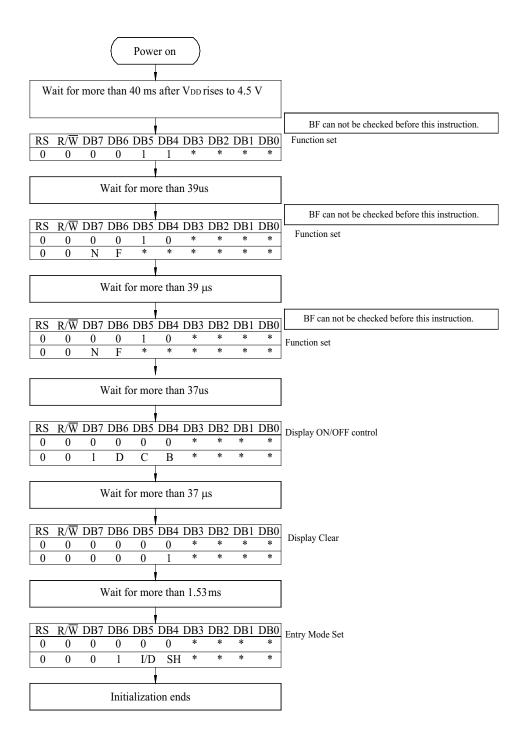


Ta=25°C, VDD=5V

Item	Symbol	Min	Тур	Max	Unit
Enable cycle time	$T_{\rm C}$	1200	_	_	ns
Enable pulse width (high level)	$T_{PW}$	140	_	_	ns
Enable rise/fall time	$T_R, T_F$	_	_	25	ns
Address set-up time (RS, R/W to E)	$t_{AS}$	0	_	_	ns
Address hold time	$t_{ m AH}$	10	_	_	ns
Data delay time	t <sub>DDR</sub>	_	_	100	ns
Data hold time	$t_{\mathrm{H}}$	10	_	_	ns

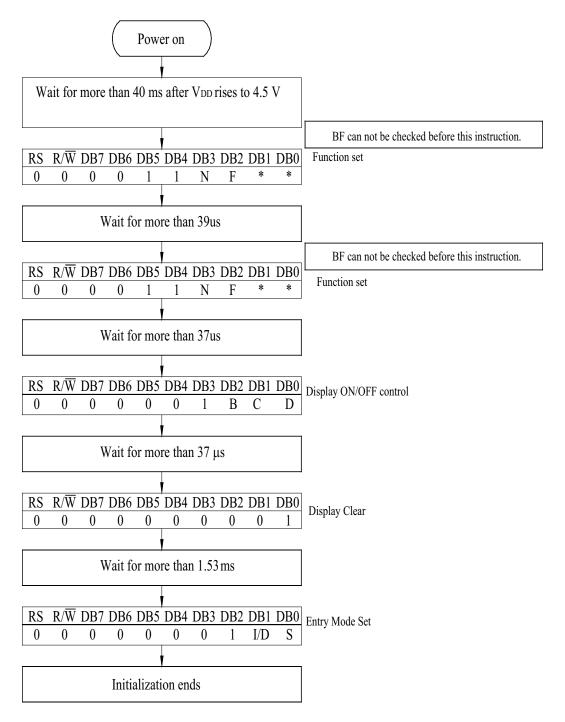


# 13. Initializing of LCM



4-Bit Ineterface

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8-Bit Ineterface



# 14. Reliability

Content of Reliability Test (wide temperature, -20°c~70°C)

	Environmental Test		
Test Item	Content of Test	<b>Test Condition</b>	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2
Low Temperature storage	Endurance test applying the high storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity Operation	The module should be allowed to stand at 60 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C  30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5k $\Omega$ CS=100pF 1 time	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: Vibration test will be conducted to the product itself without putting it in a container.



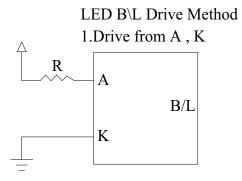
# 15. Backlight Information

## **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	14.4	16	20	mA	V=3.5V
Supply Voltage	V	3.4	3.5	3.6	V	_
Reverse Voltage	VR	_	_	10	V	_
Luminous Intensity	IV	264	330	_	CD/M <sup>2</sup>	ILED=16mA
Wave Length	λp		_	_	nm	ILED =16mA
LED Life Time (For Reference only)	_	_	50K	_	Hr.	ILED≦16mA 25°C,50-60%RH, (Note 1)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:10K hours is only an estimate for reference.





# 16. Inspection Specification

NO	Item			Criterion		AQL				
01	Electrical Testing	1.2 Missing char 1.3 Display malf 1.4 No function 1.5 Current cons 1.6 LCD viewing 1.7 Mixed produ	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>							
02	Black or white spots on LCD (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>								
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type: $\Phi = (x + y) / A$ 3.2 Line type: (A)	Y Y As followi	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$ and drawing)	2 1 0 0	2.5				
		→ L W	Length  L≦3.0  L≦2.5	$\begin{tabular}{ll} Width \\ W \le 0.02 \\ 0.02 < W \le 0.03 \\ 0.03 < W \le 0.05 \\ 0.05 < W \\ \end{tabular}$	Acceptable Q TY Accept no dense 2 As round type	2.5				
04	Polarizer bubbles	If bubbles are vis judge using black specifications, no to find, must che specify direction	k spot ot easy eck in	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5				



NO	Item		Criterion		AQL
05	Scratches	Follow NO.3 LCD blace	ek spots, white spots, con	ntamination	
		k: Seal width t: L: Electrode pad length 6.1 General glass chip	Glass thickness a: LC	-	
		z: Chip thickness	y: Chip width	x: Chip length	
	Chipped	Z≦1/2t	Not over viewing area	x ≦ 1/8a	
06	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≦ 1/8a	2.5
		6.1.2 Corner crack:	chips, x is total length of	y	
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x ≤ 1/8a	
		$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	
		⊙ If there are 2 or more	chips, x is the total lengtl	n of each chip.	



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NO	Item	Criterion	AQL
		Symbols: x: Chip ength y: Chip width z: Chip thickness k: Seal width t: Glass thickness a: LCD side length L: Electrode pad length 6.2 Protrusion over terminal: 6.2.1 Chip on electrode pad:	
		y: Chip width x: Chip length z: Chip thickness	
		$y \le 0.5 \text{mm} \qquad \qquad x \le 1/8 \text{a} \qquad \qquad 0 < z \le t$	
06	Glass	6.2.2 Non-conductive portion:	2.5
		y: Chip width x: Chip length z: Chip thickness	
		$y \le L \qquad \qquad x \le 1/8a \qquad \qquad 0 < z \le t$	
		<ul> <li>⊙ If the chipped area touches the ITO terminal, over 2/3 of the ITO must remain and be inspected according to electrode terminal specifications.</li> <li>⊙ If the product will be heat sealed by the customer, the alignment mark not be damaged.</li> <li>6.2.3 Substrate protuberance and internal crack.</li> <li>y: width x: length</li> <li>y ≤ 1/3L x ≤ a</li> </ul>	



NO	Item	Criterion					
07	Cracked glass	The LCD with extensive crack is not acceptable.					
08	Backlight elements						
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination. 9.2 Bezel must comply with job specifications.					
10	РСВ • СОВ	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul>					
11	Soldering	<ul> <li>X * Y&lt;=2mm²</li> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65				

NO	Item Criterion			
12	General appearance	<ul> <li>12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.</li> <li>12.2 No cracks on interface pin (OLB) of TCP.</li> <li>12.3 No contamination, solder residue or solder balls on product.</li> <li>12.4 The IC on the TCP may not be damaged, circuits.</li> <li>12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it causes the interface pin to sever.</li> <li>12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color.</li> <li>12.7 Sealant on top of the ITO circuit has not hardened.</li> </ul>	2.5 0.65 2.5 2.5 2.5 2.5 0.65 0.65 0.65	



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12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging	0.65
specification sheet.  12.11 Product dimension and structure must conform to product specification sheet.	

# 17. Material List of Components for RoHS

1. Declaration that all of or part of products (with the mark "N" in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

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Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs		
Limited Value	100 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm	1000 ppm		
Above limited value is set up according to RoHS.								

- 2. Process for RoHS requirement:
- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow: 250C, 30 seconds Max.;

Connector soldering wave or hand soldering: 320C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235C±5 degrees;

Recommended customer's soldering temp. of connector: 280C, 3 seconds.



## **Legal Disclaimer Notice**

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